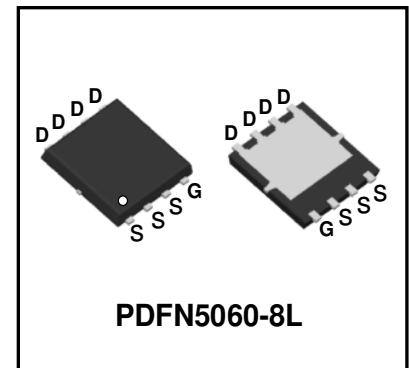


## 65V N-Channel Enhancement Mode Power MOSFET

**Description**

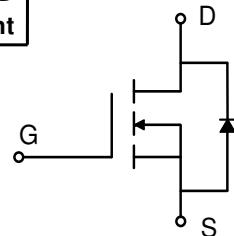
WMB048NV6LG2 uses Wayon's 2<sup>nd</sup> generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

**Features**

- $V_{DS} = 65V$ ,  $I_D = 95A$
- $R_{DS(on)} < 5.2m\Omega$  @  $V_{GS} = 10V$
- $R_{DS(on)} < 7.6m\Omega$  @  $V_{GS} = 4.5V$
- Green Device Available
- 100% EAS Guaranteed

**Applications**

- DC/DC Converter
- Synchronous Rectification

**Absolute Maximum Ratings ( $T_A = 25^\circ C$ , unless otherwise noted)**

| Parameter  | Symbol            | Value      | Unit |
|--|-------------------|------------|------|
| Drain-Source voltage                             | $V_{DS}$          | 65         | V    |
| Gate-Source voltage                              | $V_{GS}$          | $\pm 20$   | V    |
| Continuous Drain Current<br><br>$T_C=25^\circ C$ | $I_D$             | 95         | A    |
| $T_C=100^\circ C$                                |                   | 61         |      |
| Pulsed Drain Current <sup>1</sup>                | $I_{DM}$          | 380        | A    |
| Single Pulse Avalanche Energy <sup>2</sup>       | <b>EAS</b>        | 51.2       | mJ   |
| Total Power Dissipation<br><br>$T_C=25^\circ C$  | $P_D$             | 75         | W    |
| Operating Junction and Storage Temperature Range | $T_J$ , $T_{STG}$ | -55 to 150 | °C   |

**Thermal Characteristics**

| Parameter  | Symbol          | Value | Unit |
|--|-----------------|-------|------|
| Thermal Resistance from Junction-to-Ambient <sup>3</sup> | $R_{\theta JA}$ | 49    | °C/W |
| Thermal Resistance from Junction-to-Case                 | $R_{\theta JC}$ | 1.66  | °C/W |

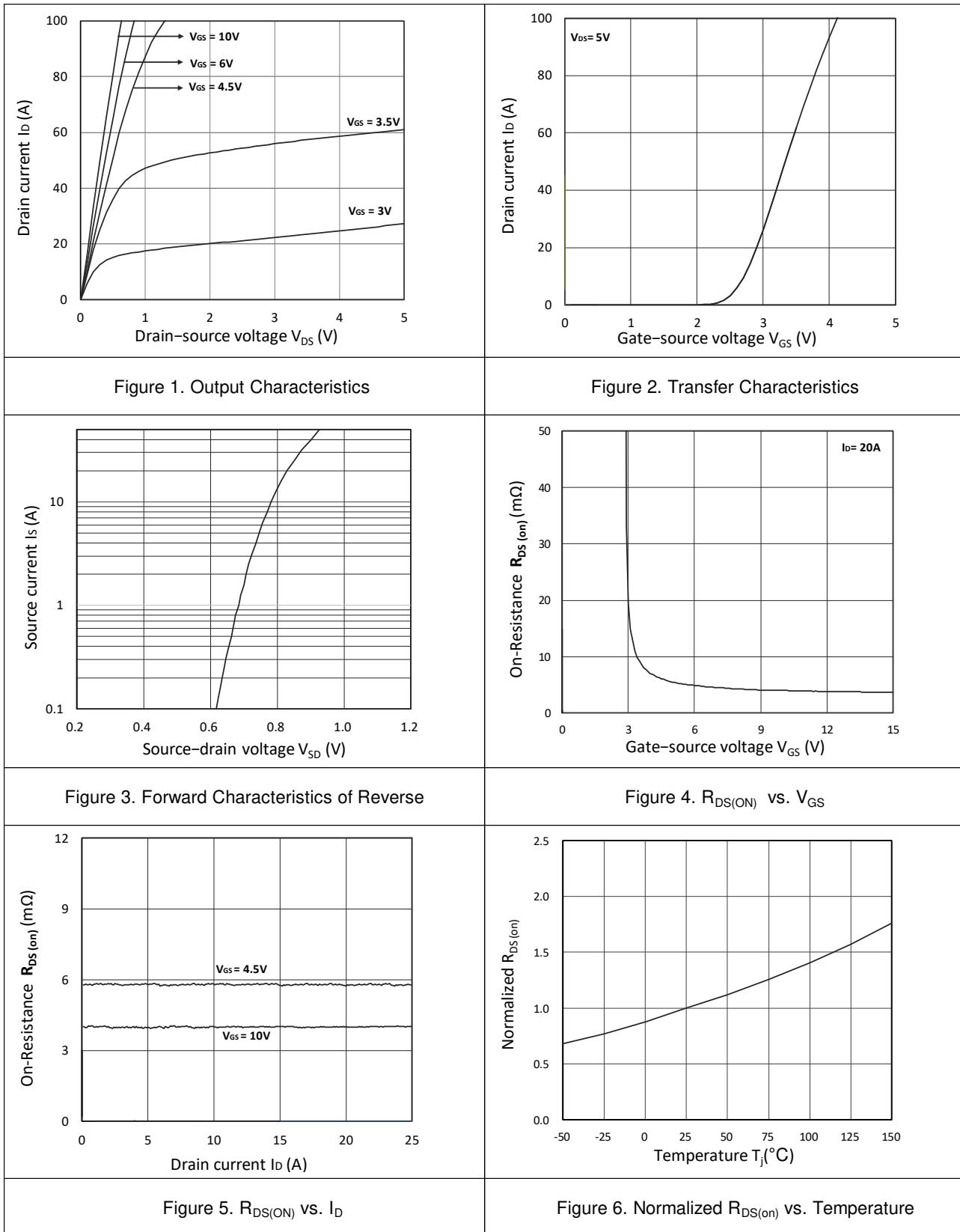
**Electrical Characteristics ( $T_J = 25^\circ\text{C}$ , unless otherwise noted)**

| Parameter   | Symbol                      | Test Conditions  | Min. | Typ. | Max.      | Unit             |
|---|-----------------------------|--|------|------|-----------|------------------|
| <b>Static Characteristics</b>                             |                             |  |      |      |           |                  |
| Drain-Source Breakdown Voltage                            | $V_{(\text{BR})\text{DSS}}$ | $V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$  | 65   | -    | -         | V                |
| Gate-body Leakage Current                                 | $I_{\text{GSS}}$            | $V_{\text{DS}} = 0\text{V}, V_{\text{GS}} = \pm 20\text{V}$                                | -    | -    | $\pm 100$ | nA               |
| Zero Gate Voltage Drain Current<br>$T_J=25^\circ\text{C}$ | $I_{\text{DSS}}$            | $V_{\text{DS}} = 60\text{V}, V_{\text{GS}} = 0\text{V}$                                    | -    | -    | 1         | $\mu\text{A}$    |
| $T_J=100^\circ\text{C}$                                   |                             |  | -    | -    | 100       |                  |
| Gate-Threshold Voltage                                    | $V_{\text{GS}(\text{th})}$  | $V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$                                      | 1.0  | 1.6  | 2.4       | V                |
| Drain-Source On-Resistance <sup>4</sup>                   | $R_{\text{DS}(\text{on})}$  | $V_{\text{GS}} = 10\text{V}, I_D = 20\text{A}$   | -    | 4.0  | 5.2       | $\text{m}\Omega$ |
|   |                             | $V_{\text{GS}} = 4.5\text{V}, I_D = 10\text{A}$  | -    | 5.8  | 7.6       |                  |
| Forward Transconductance <sup>4</sup>                     | $g_{\text{fs}}$             | $V_{\text{DS}} = 5\text{V}, I_D = 20\text{A}$  | -    | 61   | -         | S                |
| <b>Dynamic Characteristics<sup>5</sup></b>                |                             |  |      |      |           |                  |
| Input Capacitance   | $C_{\text{iss}}$            | $V_{\text{DS}} = 30\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$                   | -    | 2250 | -         | $\text{pF}$      |
| Output Capacitance  | $C_{\text{oss}}$            |  | -    | 886  | -         |                  |
| Reverse Transfer Capacitance                              | $C_{\text{rss}}$            |  | -    | 75   | -         |                  |
| Gate Resistance   | $R_g$                       | $f = 1\text{MHz}$  | -    | 1.4  | -         | $\Omega$         |
| <b>Switching Characteristics<sup>5</sup></b>              |                             |  |      |      |           |                  |
| Total Gate Charge   | $Q_g$                       | $V_{\text{GS}} = 10\text{V}, V_{\text{DS}} = 30\text{V}, I_D = 20\text{A}$                 | -    | 35   | -         | $\text{nC}$      |
| Gate-Source Charge  | $Q_{\text{gs}}$             |  | -    | 4    | -         |                  |
| Gate-Drain Charge   | $Q_{\text{gd}}$             |  | -    | 9.5  | -         |                  |
| Turn-On Delay Time  | $t_{\text{d}(\text{on})}$   | $V_{\text{GS}} = 10\text{V}, V_{\text{DD}} = 30\text{V}, R_G = 10\Omega, I_D = 20\text{A}$ | -    | 8.8  | -         | $\text{ns}$      |
| Rise Time   | $t_r$                       |  | -    | 7    | -         |                  |
| Turn-Off Delay Time                                       | $t_{\text{d}(\text{off})}$  |  | -    | 30   | -         |                  |
| Fall Time   | $t_f$                       |  | -    | 8.8  | -         |                  |
| Reverse Recovery Time                                     | $t_{\text{rr}}$             |  | -    | 26   | -         | $\text{ns}$      |
| Reverse Recovery Charge                                   | $Q_{\text{rr}}$             | $I_f = 20\text{A}, dI_f/dt = 400\text{A}/\mu\text{s}$                                      | -    | 62   | -         | $\text{nC}$      |
| <b>Drain-Source Body Diode Characteristics</b>            |                             |  |      |      |           |                  |
| Diode Forward Voltage <sup>4</sup>                        | $V_{\text{SD}}$             | $I_s = 20\text{A}, V_{\text{GS}} = 0\text{V}$  | -    | -    | 1.2       | V                |
| Continuous Source Current                                 | $T_c = 25^\circ\text{C}$    | $I_s$  | -    | -    | 95        | A                |

**Notes:**

- Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})} = 150^\circ\text{C}$
- The EAS data shows Max. rating . The test condition is  $V_{\text{DD}} = 25\text{V}, V_{\text{GS}} = 10\text{V}, L = 0.1\text{mH}, I_{\text{AS}} = 32\text{A}$
- The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- The data tested by pulsed , pulse width  $\leq 300\mu\text{s}$  , duty cycle  $\leq 2\%$ .
- This value is guaranteed by design hence it is not included in the production test..

## Typical Characteristics



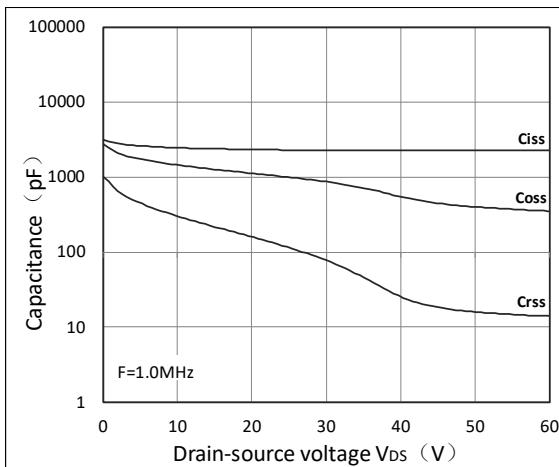


Figure 7. Capacitance Characteristics

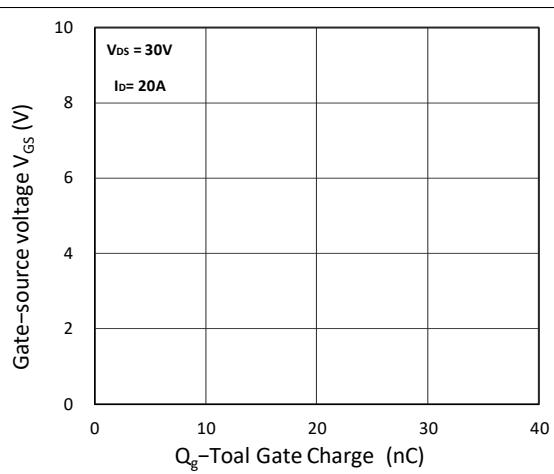


Figure 8. Gate Charge Characteristics

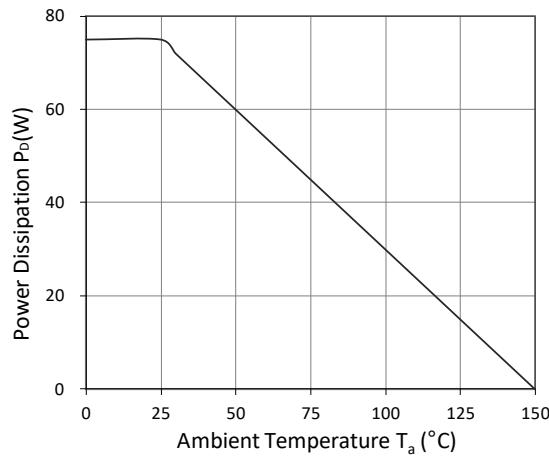


Figure 9. Power Dissipation

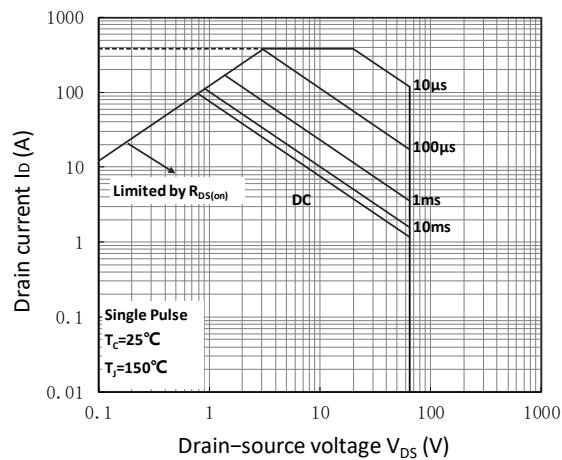


Figure 10. Safe Operating Area

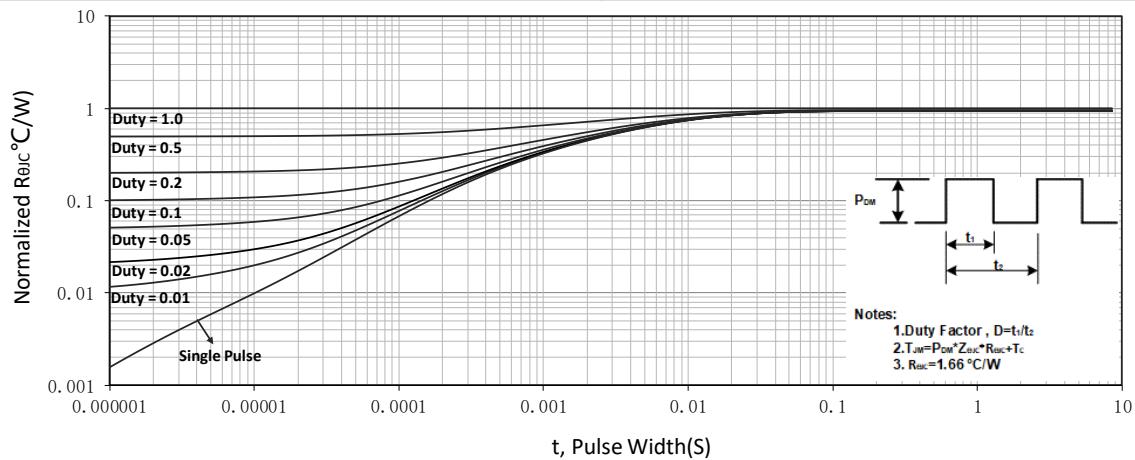
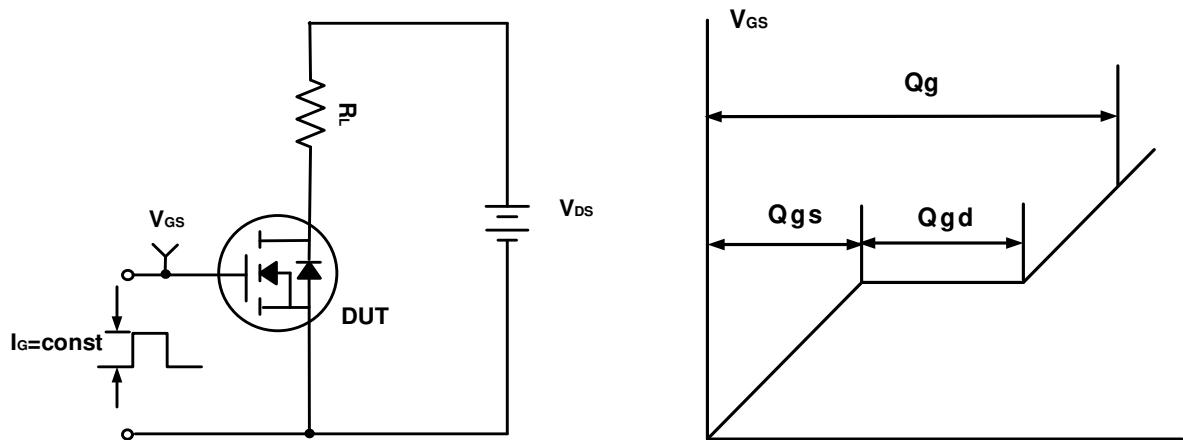
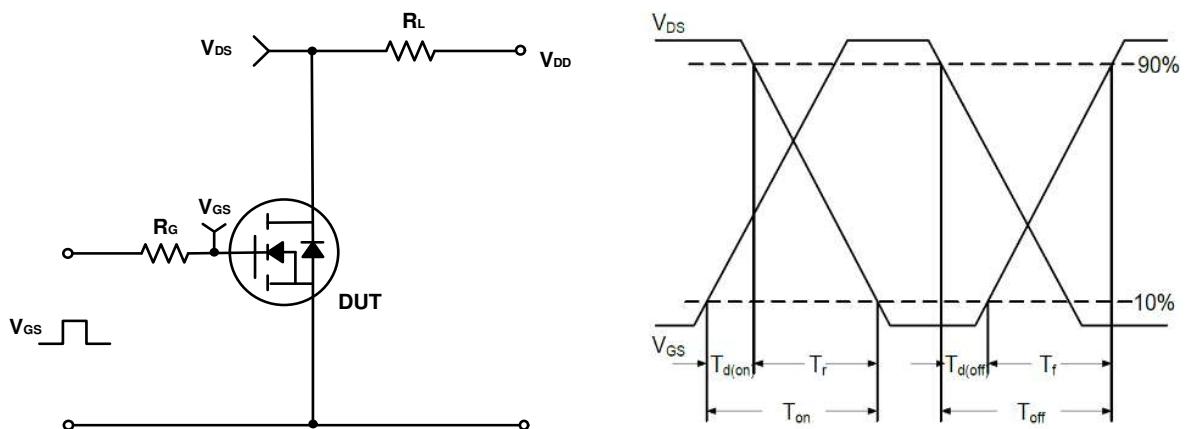
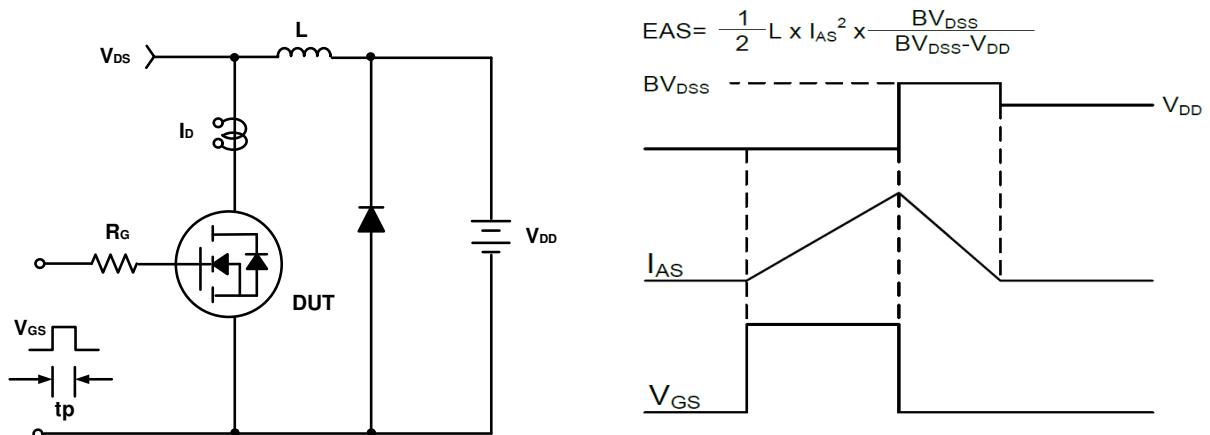
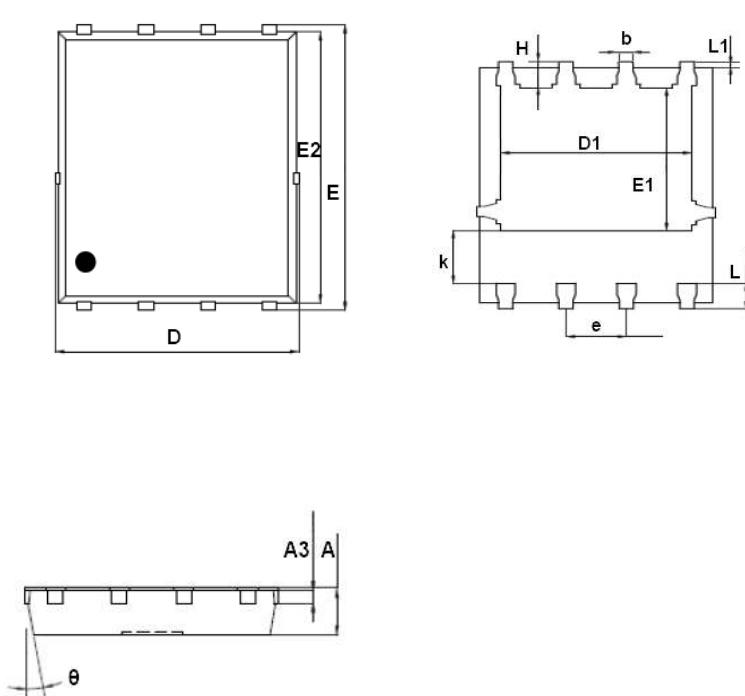


Figure 11. Normalized Maximum Transient Thermal Impedance

**Test Circuit****Figure A. Gate Charge Test Circuit & Waveforms****Figure B. Switching Test Circuit & Waveforms****Figure C. Unclamped Inductive Switching Circuit & Waveforms**

## Mechanical Dimensions for PDFN5060-8L



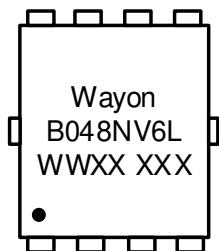
## COMMON DIMENSIONS

| SYMBOL | MM      |      |
|--------|---------|------|
|        | MIN     | MAX  |
| A      | 0.90    | 1.20 |
| A3     | 0.15    | 0.35 |
| D      | 4.80    | 5.40 |
| E      | 5.90    | 6.35 |
| D1     | 3.61    | 4.31 |
| E1     | 3.30    | 3.92 |
| E2     | 5.50    | 6.06 |
| k      | 1.10    | -    |
| b      | 0.30    | 0.51 |
| e      | 1.27BSC |      |
| L      | 0.38    | 0.71 |
| L1     | 0.05    | 0.36 |
| H      | 0.38    | 0.71 |
| θ      | 0°      | 12°  |

## Ordering Information

| Part         | Package     | Marking  | Packing method |
|--------------|-------------|----------|----------------|
| WMB048NV6LG2 | PDFN5060-8L | B048NV6L | Tape and Reel  |

## Marking Information



B048NV6L = Device code

WWXX XXX= Date code

## Contact Information

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WAYON website: <http://www.way-on.com>

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